

High Efficiency Regulator Controller

FEATURES

- Complete Control for a High Current, Low Dropout, Linear Regulator
- Fixed 5V or Adjustable Output Voltage
- Accurate 2.5A Current Limiting with Foldback
- Internal Current Sense Resistor
- Remote Sense for Improved Load Regulation
- External Shutdown
- Under-Voltage Lockout and Reverse Voltage Protection
- Thermal Shutdown Protection
- 8 Pin Mini-Dip Package (Surface Mount also Available)

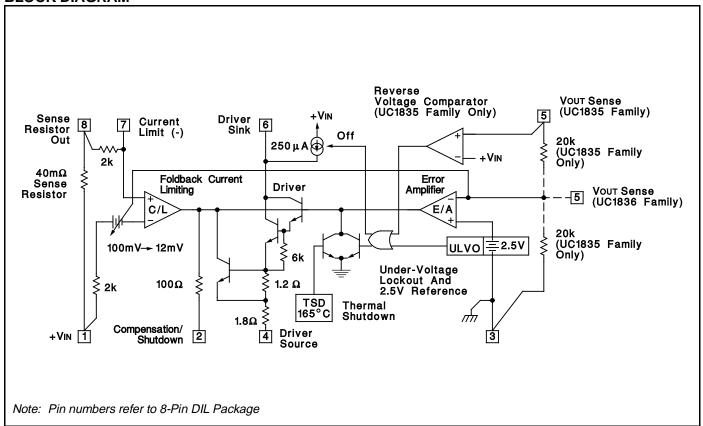
DESCRIPTION

The UC1835/6 families of linear controllers are optimized for the design of low cost, low dropout, linear regulators. Using an external pass element, dropout voltages of less than 0.5V are readily obtained. These devices contain a high gain error amplifier, a 250mA output driver, and a precision reference. In addition, current sense with foldback provides for a 2.5A peak output current dropping to less than 0.5A at short circuit.

These devices are available in fixed, 5V, (UC1835), or adjustable, (UC1836), versions. In the fixed 5 volt version, the only external parts required are an external pass element, an output capacitor, and a compensation capacitor. On the adjustable version the output voltage can be set anywhere from 2.5V to 35V with two external resistors.

Additional features of these devices include under-voltage lockout for predictable start-up, thermal shutdown and short circuit current limiting to protect the driver device. On the fixed voltage version, a reverse voltage comparator minimizes reverse load current in the event of a negative input to output differential.

BLOCK DIAGRAM

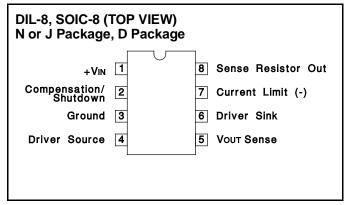


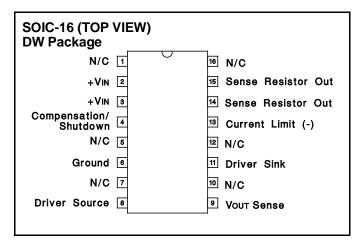
ABSOLUTE MAXIMUM RATINGS (Note 1)

Input Supply Voltage (+VIN)1.0V to +	40V
Driver Output Current (Sink or Source) 600)mA
Driver Source to Sink Voltage +	40V
Maximum Current Through Sense Resistor	. 4A
Vout Sense Input Voltage	40V
Power Dissipation at TA = 25°C (Note 2) 1000	mW
Power Dissipation at Tc = 25°C (Note 2) 2000	mW

Operating Junction Temperature55°C to +150°C
Storage Temperature65°C to +150°C
Lead Temperature (Soldering, 10 Seconds) 300°C
Note 1: Voltages are referenced to ground, (Pin 3). Currents are
positive into, negative out of, the specified terminals.
Consult Packaging Section of Databook for thermal
considerations and limitations of packages.

CONNECTION DIAGRAMS





PLCC-20, LCC-20 (TOP VIEW)						
Q, L Packages	PACKAGE PIN FUNCT	PIN				
_	N/C	1				
	+VIN					
		2				
	+VIN	3				
3 2 1 20 19	N/C	4				
4 18	Compensation/ Shutdown	5				
[5 17]	N/C	6				
6 16	Ground	7				
7 15	N/C	8				
8 14	N/C	9				
9 10 11 12 13	Driver Source	10				
	N/C	11				
	Vout Sense	12				
	N/C	13				
	N/C	14				
	Driver Sink	15				
	N/C	16				
	Current Limit (-)	17				
	N/C	18				
	Sense Resistor Out	19				
	Sense Resistor Out	20				
·						

ELECTRICAL CHARACTERISTICS: Unless otherwise stated, specifications hold for TA = 0° C to + 70° C for the UC3835/6, -25°C to + 85°C for the UC2835/6, and -55°C to +125°C for the UC1835/6, +VIN = 6V, Driver Source= 0V, Driver Sink = 5V, TA = TJ.

PARAMETER	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Supply					
Supply Current	+VIN = 6V		2.75	4.0	mA
	+VIN = 40V		3.75	6.0	mA
UVLO Threshold	+VIN Low to High, VOUT Sense = 0V	3.9	4.4	4.9	V
Threshold Hysteresis			0.1	0.35	V
Reverse Current	+VIN = -1.0V, Driver Sink Open		6.0	20	mA
Regulating Voltage and Error Amplifier (UC	C1835 Family Only)				
Regulating Level at Vout Sense (VREG)	Driver Current = 10mA, TJ = 25°C	4.94	5.0	5.06	V
	Over Temperature	4.9		5.1	V
Line Regulation	+VIN = 5.2V + 35V		15	40	mV
Load Regulation	Driver Current = 0 to 250mA		6.0	25	mV
Bias Current at Vou⊤ Sense	Vout Sense = 5.0V	75	125	210	μΑ
Error Amp Transconductance	±100μA at Compensation/Shutdown Pin	0.8	1.3	2.0	mS
Maximum Compensation Output Current	Sink or Source, Driver Source Open	90	200	260	μΑ

ELECTRICAL CHARACTERISTICS: Unless otherwise stated, specifications hold for Ta = 0°C to + 70°C for the UC3835/6, -25°C to + 85°C for the UC2835/6, and -55°C to +125°C for the UC1835/6, +VIN = 6V, Driver Source= 0V, Driver Sink = 5V, Ta = TJ.

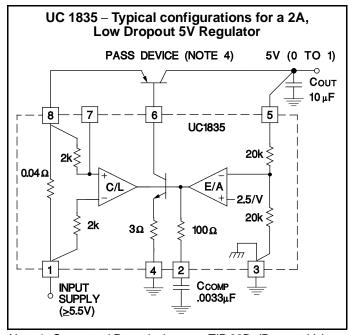
PARAMETER	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Regulating Voltage and Error Amplifier (UC1836 Family Only)								
Regulating Level at Vout Sense (VREG)	Driver Current = 10mA, T _J = 25°C	2.47	2.5	2.53	V			
	Over Temperature	2.45		2.55	V			
Line Regulation	+VIN = 5.2V to 35V		6.0	20	mV			
Load Regulation	Driver Current = 0 to 250mA		3.0	15	mV			
Bias Current at Vout Sense	Vout Sense =2.5V	-1.0	-0.2		μΑ			
Error Amp Transconductance	±100μA at Compensation/Shutdown Pin	0.8	1.3	2.0	mS			
Maximum Compensation Output Current	Sink or Source, Driver Source Open	90	200	260	μΑ			
Driver								
Maximum Current		250	500		mA			
Saturation Voltage	Driver Current = 250mA, Driver Sink		2.0	2.8	V			
Pull-Up Current at Driver Sink	Compensation/Shutdown=0.45V	140	250	300	μΑ			
Driver Sink Leakage	In UVLO			10	μΑ			
	In Reverse Voltage (UC1835 Family Only)			10	μΑ			
Thermal Shutdown			165		°C			
Foldback Current Limit					_			
Current Limit Levels at Sense Resistor Out	Vout Sense = (0.99) VREG	2.2	2.5	2.8	Α			
	Vout Sense = (0.5) VREG	1.3	1.5	1.7	Α			
	Vout Sense = 0V	0.25	0.4	0.55	Α			
Current Limit Amp Tansconductance	$\pm 100 \mu A$ at Compensation/Shutdown, VOUT Sense = (0.9) VREG	12	24	42	mS			
Limiting Voltage at Current Limit (-) (Note 2)	Vout Sense = (0.9) VREG Volts Below +VIN, TJ = 25°C	80	100	140	mV			
Sense Resistor Value (Note 3)	V _{OUT} Sense = (0.9) V _{REG} , I _{OUT} = I _A , T _J = 25°C		40		mΩ			

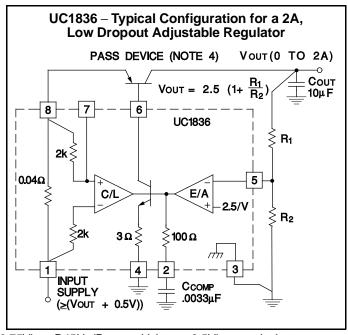
Note 2: This voltage has a positive temperature coefficient of approximately 3500ppm/°C.

Note 3: This resistance has a positive temperature coefficient of approximately 3500ppm/°C.

The total resistance from Pin 1 to Pin 8 will include an additional 60 to $100m\Omega$ of package resistance.

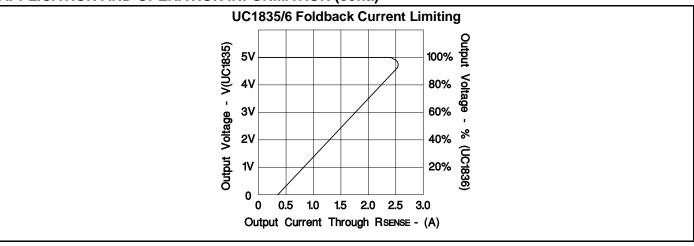
APPLICATION AND OPERATION INFORMATION





Note 4: Suggested Pass devices are TIP 32B. (Dropout Voltage ≤0.75V) or, D45H, (Dropout Voltage ≤0.5V), or equivalents.

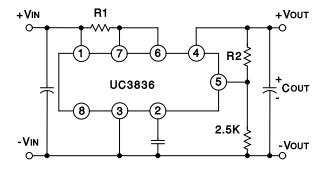
APPLICATION AND OPERATION INFORMATION (cont.)



UC3835/36 TYPICAL APPLICATIONS

Low Current Application

using the UC3836 internal drive transistor



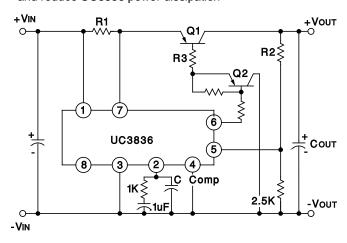
Typical Output Current vs VIN and VOUT

of the UC3836 internal drive transistor for PDISS = 0.5W (approx.)

		Vin						
	Volts	5	9	12	15	18	24	
	2	150	60	40	30	20	12	
VOUT	5	105	55	35	25	15		
••••	9			130	60	35	20	
	12				120	55	25	
	15	Cur	110	30				

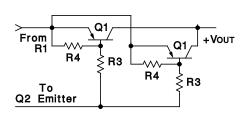
High Current Application

using drive transistor Q2 to increase Q1 base drive and reduce UC3836 power dissipation



Parallel Pass Transistors

can be added for high current or high power dissipation applications



EQUATIONS:

R1 = 0.100 V/Iout (MAX)

 $R_2 = (VOUT - 2.5V/1mA)$

R3 = ((VIN - VBE - VSAT)*BETA(min))/IOUT (max)

www.ti.com

18-Nov-2025

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
5962-9065002PA	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	9065002PA UC1836
UC1836J	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	UC1836J
UC1836J.A	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	UC1836J
UC1836J883B	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	9065002PA UC1836
UC1836J883B.A	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	9065002PA UC1836
UC2835D	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2835D
UC2835D.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2835D
UC2836D	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2836D
UC2836D.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2836D
UC2836DG4	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2836D
UC3836D	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3836D
UC3836D.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3836D

⁽¹⁾ Status: For more details on status, see our product life cycle.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

www.ti.com 18-Nov-2025

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF UC1836, UC3836:

Catalog: UC3836

Military: UC1836

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

www.ti.com 23-May-2025

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
UC2835D	D	SOIC	8	75	506.6	8	3940	4.32
UC2835D.A	D	SOIC	8	75	506.6	8	3940	4.32
UC2836D	D	SOIC	8	75	506.6	8	3940	4.32
UC2836D.A	D	SOIC	8	75	506.6	8	3940	4.32
UC2836DG4	D	SOIC	8	75	506.6	8	3940	4.32
UC3836D	D	SOIC	8	75	506.6	8	3940	4.32
UC3836D.A	D	SOIC	8	75	506.6	8	3940	4.32

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale, TI's General Quality Guidelines, or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2025, Texas Instruments Incorporated

Last updated 10/2025